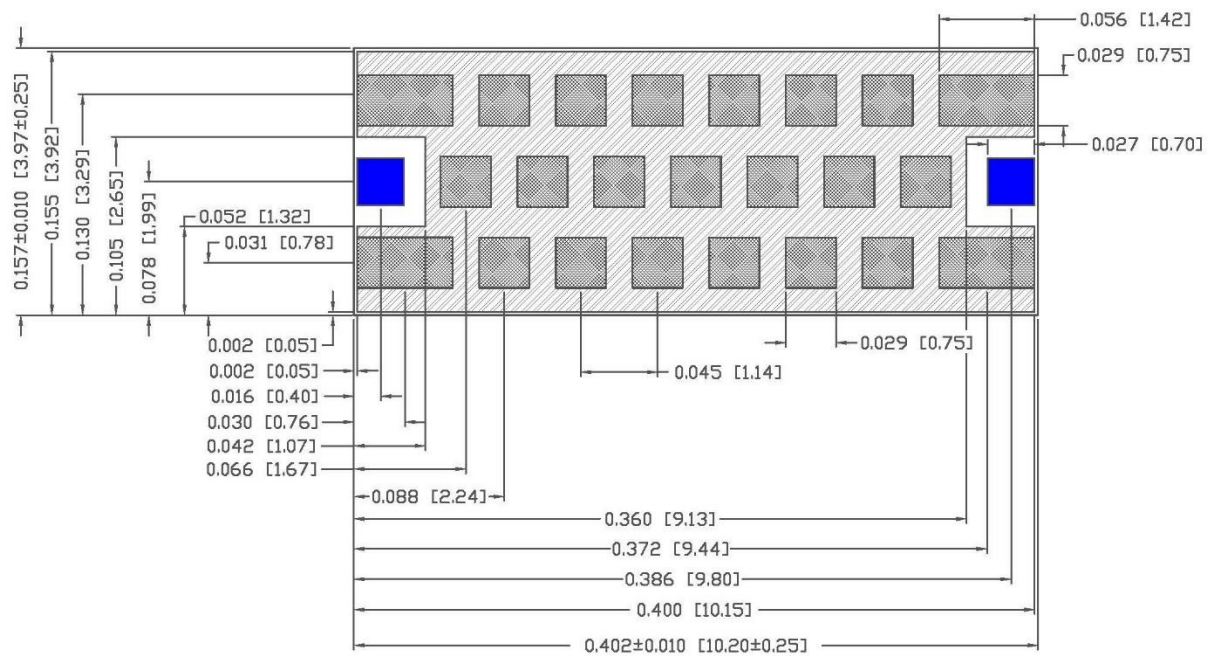


Footprint D Device Layout



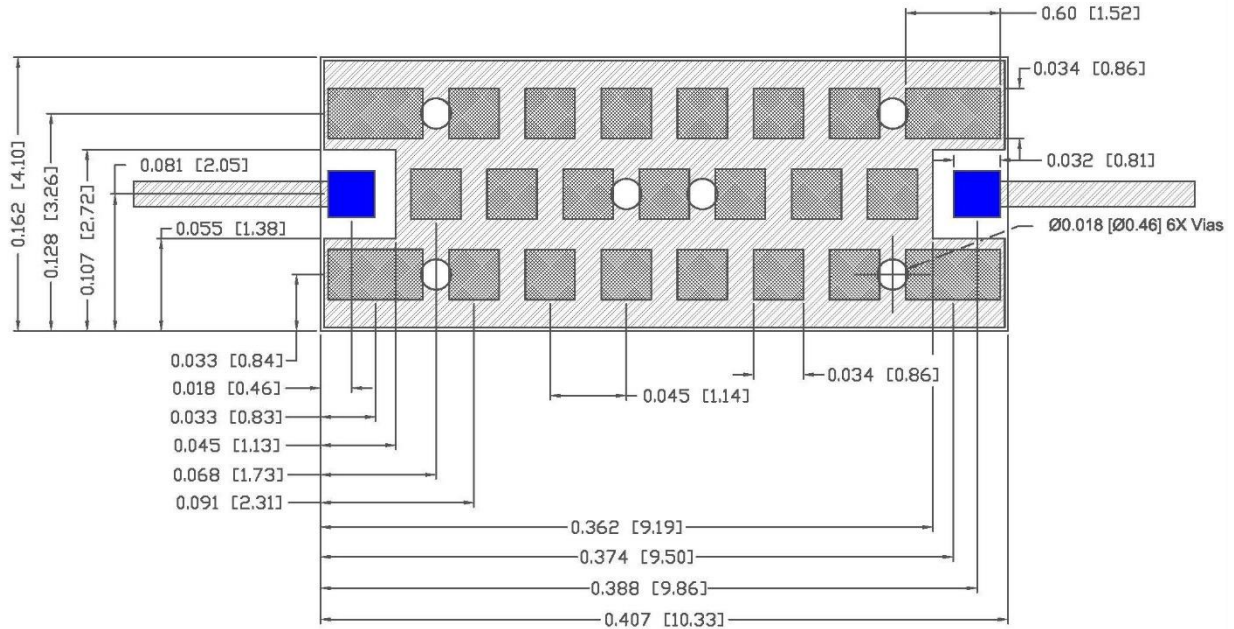
Dimensions in inches [mm]

Tolerances are +/-0.002 [0.05], unless noted.

Dimensions nominal unless otherwise noted.

All contact areas are gold plated, including I/O pads.

Footprint D Suggested PCB Layout



Dimensions in inches [mm].

Dimensions nominal unless otherwise noted.

Line width for I/O pads should be designed to match 50-ohm characteristic impedance, depending on PCB material and thickness. Grounding for these lines not shown.

All contact areas are gold plated, including I/O pads.

Grounding is solid copper under solder mask, with solder mask defined pads for ground openings. I/O pads are not shorted to ground.

Footprint D Device Layout L X W

